NXP

Customer Information Notification | 201612018l

Issue Date: 13-Feb-2017
Effective Date: 14-Feb-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

QUALITY

Change Category

[ ] Wafer Fab Process	[ ] Assembly Process	[ ] Product Marking	[ ] Test Location	[ ] Design
[ ] Wafer Fab Materials	[ ] Assembly Materials	[ ] Mechanical Specification	[ ]Test Process	[ ] Errata
[ ] Wafer Fab Location	[ ] Assembly Location	[ ] Packing/Shipping/Labeling	[ ] Test Equipment	[X] Electrical spec./Test coverage

MPC5746C Reference Manual Update Rev 4.

Information Notification

The MPC5746C Reference Manual (RM) has been updated to revision 4:
The revision history included in the updated RM document (Appendix A) provides a detailed description of the changes.

The updated reference manual can be found at:

http://www.nxp.com/assets/documents/data/en/reference-manuals/MPC5746CRM.pdf

Why do we issue this Information Notification
The reference manual has been updated to correct errors and provide clarification on other subjects highlighted by customers.

Identification of Affected Products
Product identification does not change

Impact

no impact to the product's functionality anticipated.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality

Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:
Name   Chris Platt
Position   Applications Engineer
e-mail address   christopher.platt@nxp.com
At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

<div style="background-color:#4472C4; color:white; padding:4px;">**About NXP Semiconductors**</div>

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#	Customer Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
SPC5746CSK1MKU6	SPC5746CSK1MKU6	935322183557	SPC5746CSK1MKU6	"32 BIT,3M FLASH,384 RAM"	HLQFP176	RFS	BL Auto Micro Processors
SPC5746CSK1MMJ6	SPC5746CSK1MMJ6	935312542557	SPC5746CSK1MMJ6	"32 BIT,3M FLASH,384 RAM"	LBGA256	RFS	BL Auto Micro Processors
SPC5746CSK1MMH6	SPC5746CSK1MMH6	935316141557	SPC5746CSK1MMH6	"32 BIT,3M FLASH,384 RAM"	LBGA100	RFS	BL Auto Micro Processors